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# 1200V, 25A, Trench FS II Fast IGBT

#### **General Description:**

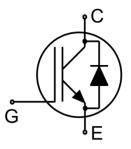
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 1200V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

#### **Features**

- Trench FSII Technology offering
- Very low V<sub>CE(sat)</sub>
- Positive temperature coefficient in V<sub>CE(sat)</sub>
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

### **Application**

- Inverters
- Motor drives
- Converter



Schematic diagram

### **Package Marking and Ordering Information**

Device	Device Package	Device Marking
NCE25TD120BT	TO-247	NCE25TD120BT



TO-247

## Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	1200	V
V <sub>GES</sub>	Gate- Emitter Voltage	±30	V
I.	Collector Current	50	Α
lc	Collector Current @T <sub>C</sub> = 100 °C	25	Α
I <sub>Cpuls</sub>	Pulsed Collector Current, t <sub>p</sub> limited by T <sub>jmax</sub>	75	Α
-	turn off safe operating area, V <sub>CE</sub> =1200V, Tj=150°C	75	Α
lF	Diode Continuous Forward Current @Tc = 100 °C	25	Α
I <sub>FM</sub>	Diode Maximum Forward Current	75	Α
<b>D</b>	Power Dissipation @ T <sub>C</sub> = 25°C	365	W
P <sub>D</sub>	Power Dissipation @T <sub>C</sub> = 100 °C	183	W
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C
t <sub>sc</sub>	Short circuit withstand time $V_{GE}$ =15.0V, $V_{CC}$ $\leqslant$ 600V, Allowed number of short circuits<1000Time between short circuits: $\geqslant$ 1.0s, $T_{j}$ $\leqslant$ 150°C	10	us

V2.0



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#### **Thermal Characteristic**

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	0.41	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	0.78	°C/W
ReJA	Thermal Resistance, Junction to Ambient	40	°C/W

## Electrical Characteristics (Tc=25°C unless otherwise noted)

Ol	Damanatan	Test Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics						
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> =0V,l	<sub>CE</sub> =1mA	1200			V
Ices	Collector-Emitter Leakage Current	V <sub>GE</sub> =0V,V	ce=1200V			5	uA
I <sub>GES(F)</sub>	Gate to Emitter Forward Leakage	V <sub>GE</sub> =+30\	/,V <sub>CE</sub> =0V			200	nA
I <sub>GES(R)</sub>	Gate to Source Reverse Leakage	V <sub>GE</sub> =-30V	,VCE =0V			200	nA
V	Collector Emitter Seturation Valtage	V <sub>GE</sub> =15V,	Tj=25°C		1.55	1.8	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> =25A,	Tj=150°C		1.8		V
V <sub>GE(th)</sub>	Gate Threshold Voltage	Ic=1mA,	Vce=Vge	5.0		6.5	V
I <sub>C(SC)</sub>	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V <sub>GE</sub> =15V,V <sub>CC</sub> ≤600V, t <sub>SC</sub> ≤10us,Tj≤150°C			120		А
Dynamic Ch	aracteristics						
Cies	Input Capacitance	V <sub>CE</sub> =30V,V <sub>GE</sub> =0V, f=1MHz			2674		pF
Coes	Output Capacitance				72		
Cres	Reverse Transfer Capacitance				59		
Qg	Total Gate Charge	Vcc=960V, Ic=25A VgE=15V			146		nC
$Q_{ge}$	Gate to Emitter Charge				28		nC
$Q_{gc}$	Gate to Collector Charge	VOL-			84		nC
Switching Cl	haracteristics						
$t_{\text{d(ON)}}$	Turn-on Delay Time				19		
<b>t</b> r	Rise Time				17		ns
t <sub>d(OFF)</sub>	Turn-Off Delay Time	Vc==600V,Ic=25A			170		113
<b>t</b> f	Fall Time	V <sub>GE</sub> =0/15\	/, R <sub>g</sub> =5Ω		18		
Eon	Turn-On Switching Loss	Inductive	e Load		1.5		
$E_{off}$	Turn-Off Switching Loss				8.0		mJ
E <sub>ts</sub>	Total Switching Loss				2.3		

## Electrical Characteristics of the Diode (Tc= 25°C unless otherwise specified):

Symbol	Parameter	Test Conditions	Rating			Units
Symbol			Min.	Тур.	Max.	Ullits
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> =25A		2.2	3.0	V
Trr	Reverse Recovery Time	I- 05A		190		ns
I <sub>RRM</sub>	Diode Peak Reverse Recovery Current	I <sub>F</sub> =25A, di/dt=500A/us		12		А
Qrr	Reverse Recovery Charge	ui/ut=500A/uS		2.5		uC
Pulse width t <sub>p</sub> ≤380μs,δ≤2%						

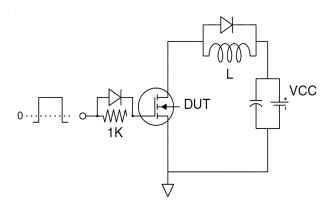


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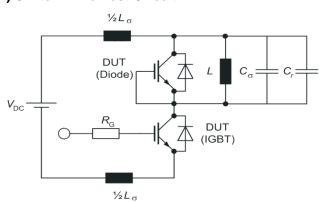
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#### **Test Circuit**

#### 1) Gate Charge Test Circuit

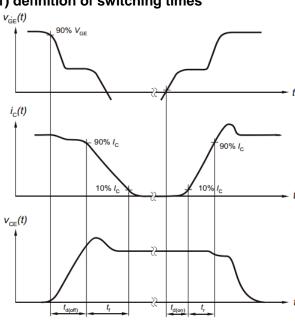


#### 2) Switch Time Test Circuit

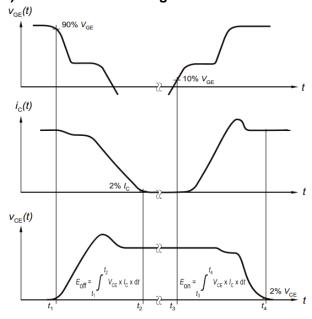


## **Switching characteristics**

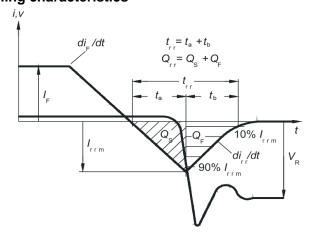
#### 1) definition of switching times



#### 2) definition of switching losses



#### 3) Definition of diode switching characteristics



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### **Typical Electrical and Thermal Characteristics**

### **Figure 1 Output Characteristics**

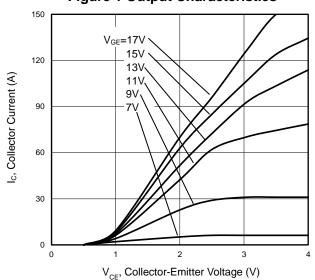
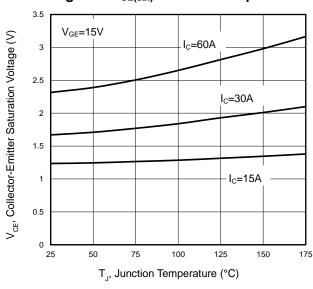


Figure 3 V<sub>CE(sat)</sub> vs. Case Temperature



**Figure 5 Capacitance Characteristics** 

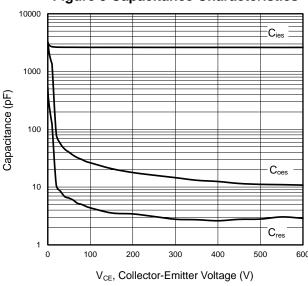


Figure 2 Transfer Characteristics

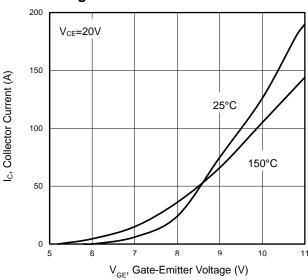
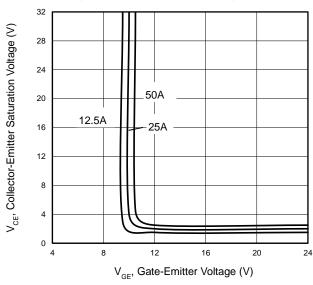
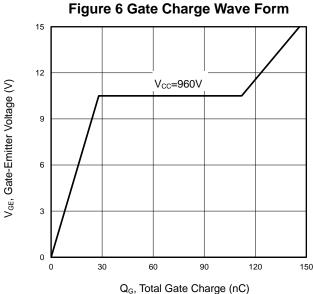


Figure 4 Saturation Voltage vs. V<sub>GE</sub>

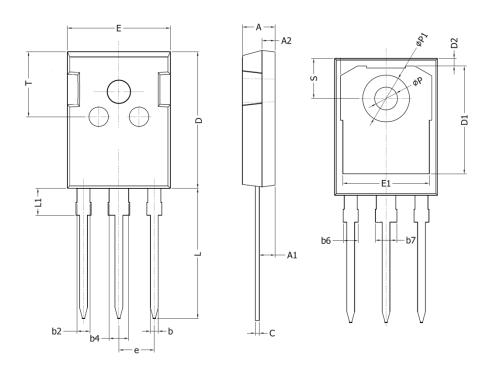




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# **TO-247-3L Package Information**



Combal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.90	5.10	0.193	0.201	
A1	2.31	2.51	0.091	0.099	
A2	1.9	2.1	0.075	0.083	
b	1.16	1.26	0.046	0.050	
b2	1.96	2.06	0.077	0.081	
b4	2.96	3.06	0.117	0.120	
b6	-	2.25	-	0.089	
b7	-	3.25	-	0.128	
С	0.59	0.66	0.023	0.026	
D	20.90	21.10	0.823	0.831	
D1	16.25	16.85	0.640	0.663	
D2	1.05	1.35	0.041	0.053	
Е	15.70	15.90	0.618	0.626	
E1	13.10	13.50	0.516	0.531	
е	5.436	BSC	0.214 BSC		
L	19.80	20.10	0.780	0.791	
L1	-	4.30	-	0.169	
Р	3.40	3.60	0.134	0.142	
P1	7.00	7.40	0.276	0.291	
S	6.05	6.25	0.238	0.246	
Т	9.80	10.20	0.386	0.402	





NCE25TD120BT

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